

Fixed Constant-Current Linear LED Driver

Features

- 20 mA ±10% Constant-Current Driver for CL520
- 25 mA ±10% Constant-Current Driver for CL525
- 1V Dropout
- 4.75V to 90V Supply Range
- 90V Maximum Rating for Transient Immunity
- Temperature Compensated

Applications

- · Specialty Lighting
- Low-Voltage Signage

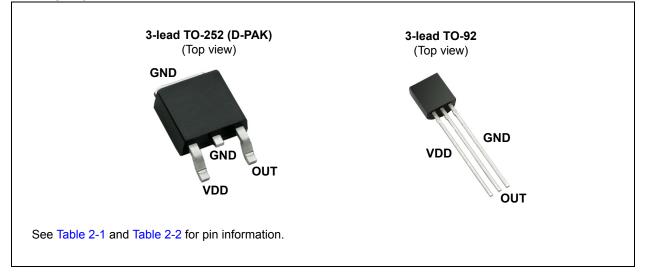
General Description

The CL520 and CL525 are fixed-current linear regulators designed for driving LEDs at 20 mA and 25 mA, respectively. With a maximum rating of 90V, these devices are able to withstand transients without the need for additional transient protection circuitry. The CL520/CL525 are ideally suited for applications employing single or multiple LEDs.

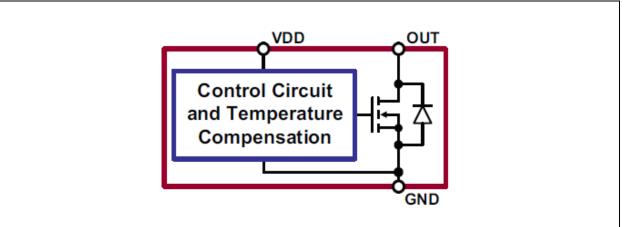
The devices' minimum dropout voltage of 1V accommodates extra LEDs, permits lower supply voltages and provides more efficient operation.

The CL520/CL525 are offered in TO-252 (D-PAK) and TO-92 packages.

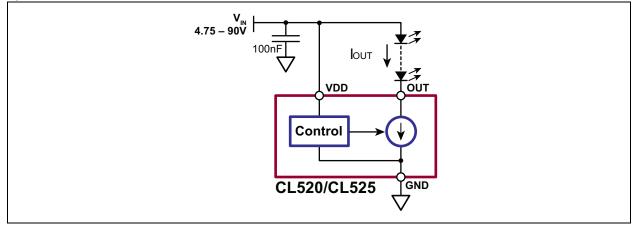
Package Types



Functional Block Diagram



Typical Application Circuit



1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings†

Supply Voltage, V _{DD}	–0.5V to +100V
Output Voltage, V _{OUT}	
Junction Temperature, T ₁	
Storage Temperature, T _S	–65°C to +150°C

† Notice: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at those or any other conditions above those indicated in the operational sections of this specification is not intended. Exposure to maximum rating conditions for extended periods may affect device reliability.

RECOMMENDED OPERATING CONDITIONS

Electrical Specifications: All voltages with respect to GND pin											
Parameter Sym. Min. Typ. Max. Unit Conditions											
Supply Voltage	V _{DD}	4.75	—	90	V						
Voltage at OUT Pin	V _{OUT}	1	_	90	V	Note 1					
Operating Junction Temperature	TJ	-40	—	+125	°C						
V _{DD} Bypass Capacitor	C _{DD}	100	—	—	nF						

Note 1: Thermal considerations may limit voltage to less than 90V.

DC ELECTRICAL CHARACTERISTICS

Electrical Specifications: Over normal recommended operating conditions unless otherwise specified. All voltages with respect to GND pin.

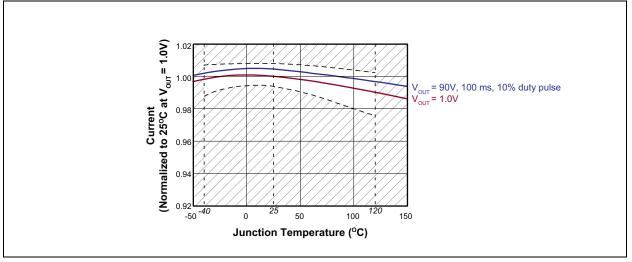
Parameter		Sym.	Min.	Тур.	Max.	Unit	Conditions
Current into V _{DD} Pin	I _{DD}			1	mA		
	CI 500		18	20	22	mA	1V < V _{OUT} < 90V
Current inte OLIT Din	CL520				22	mA	V _{OUT} < 1V
Current into OUT Pin		IOUT	22.5	25	27.5	mA	1V < V _{OUT} < 90V
	CL525				27.5	mA	V _{OUT} < 1V
Current into OUT Pin with V_{DD} F	Pin Open	I _{OUT(OFF)}			10	μA	V _{DD} = open
Voltage at V_{DD} to Shut Off LED	V _{DD(OFF)}			1	V	Ι _{ΟUT} < 10 μΑ	
V _{DD} Applied On-Time	t _{ON}	_	_	100	μs		
V _{DD} Removed Off-Time		t _{OFF}	_		100	μs	

TEMPERATURE SPECIFICATIONS

Parameter	Sym.	Min.	Тур.	Max.	Unit	Conditions
TEMPERATURE RANGE						
Operating Junction Temperature	TJ	-40	_	125	°C	
Maximum Junction Temperature	T _{J(ABSMAX)}	_	_	+135	°C	
Storage Temperature	T _S	-65	_	+150	°C	
PACKAGE THERMAL RESISTANCE	•					•
3-lead TO-252 (D-PAK)	θ_{JA}		81	_	°C/W	Note 1
3-lead TO-92	θ _{JA}	_	132	_	°C/W	Note 1

Note 1: Mounted on JEDEC test PCB (2s 2p)

I_{OUT} vs. Temperature



2.0 PIN DESCRIPTION

The pin details of CL520/CL525 3-lead TO-252 (D-PAK) and 3-lead TO-92 are listed in Table 2-1 and Table 2-2, respectively. Refer to **Package Types** for the location of pins.

TABLE 2-1:TO-252 (D-PAK) PIN FUNCTION TABLE

Pin Number	Pin Name	Description
1	VDD	Supply voltage. Bypass locally with a 100 nF capacitor to ground.
2	GND	Circuit common (not for external connection)
3	OUT	Constant-current output (sink)
4	GND	Circuit common

TABLE 2-2: TO-92 PIN FUNCTION TABLE

Pin Number	Pin Name	Description								
1	VDD	Supply voltage. Bypass locally with a 100 nF capacitor to ground.								
2	OUT	Constant-current output (sink)								
3	GND	Circuit common								

3.0 APPLICATION INFORMATION

3.1 CL520 Application Circuits

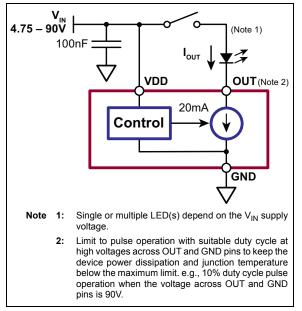


FIGURE 3-1:

CL520 Switched LED.

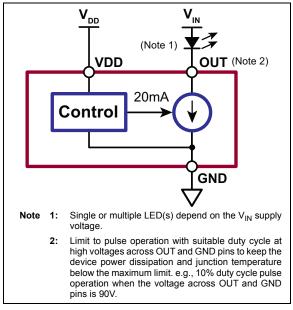
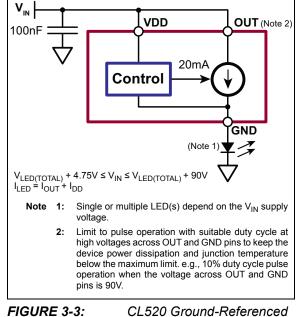
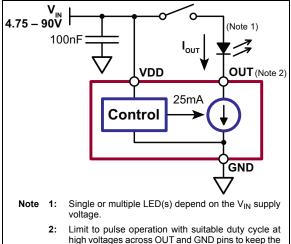


FIGURE 3-2: CL520 Separate LED Supply (V_{OUT} may be higher or lower than V_{DD} .).



LEDs.

3.2 CL525 Application Circuits



Limit to place operation with schubble day operation high voltages across OUT and GND pins to keep the device power dissipation and junction temperature below the maximum limit. e.g., 10% duty cycle pulse operation when the voltage across OUT and GND pins is 90V.

FIGURE 3-4: CL525

CL525 Switched LED.

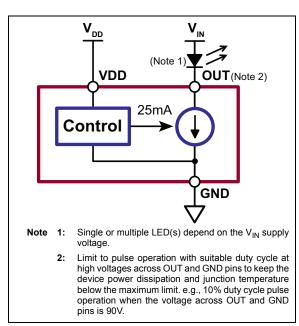


FIGURE 3-5: CL525 Separate LED Supply (V_{OUT} may be higher or lower than V_{DD} .).

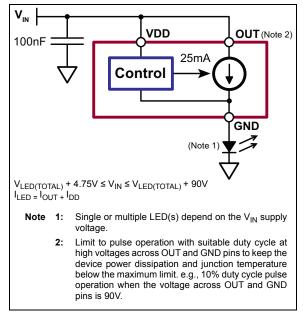
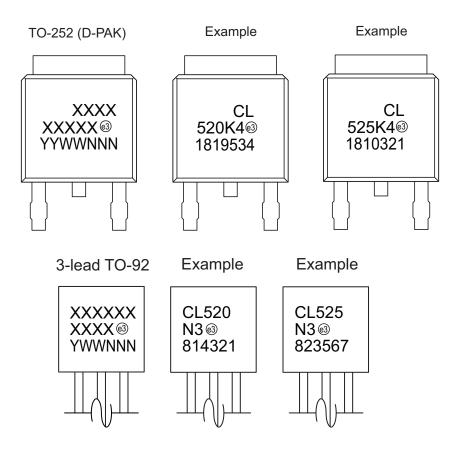


FIGURE 3-6: LEDs.

CL525 Ground-Referenced

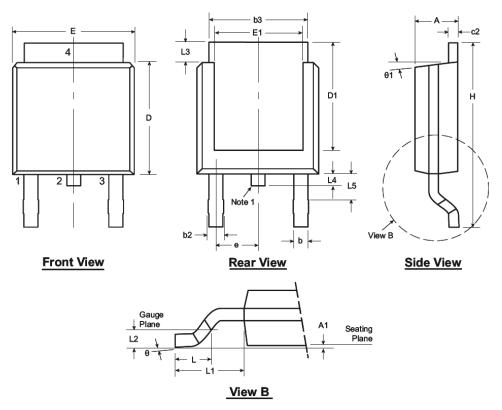
4.0 PACKAGING INFORMATION

4.1 Package Marking Information



Legend	d: XXX Y YY WW NNN @3 *	Product Code or Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code Pb-free JEDEC [®] designator for Matte Tin (Sn) This package is Pb-free. The Pb-free JEDEC designator (e3) can be found on the outer packaging for this package.
Note:	be carrie characters	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for product code or customer-specific information. Package may or e the corporate logo.

3-Lead TO-252 (D-PAK) Package Outline (K4)



Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging. *Note:*

Although 4 terminal locations are shown, only 3 are functional. Lead number 2 was removed.

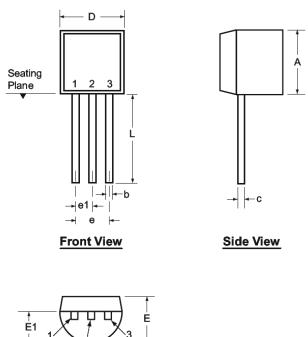
Symb	ol	A	A1	b	b2	b3	c2	D	D1	E	E1	e	H	L	L1	L2	L3	L4	L5	θ	θ1
Dimen-	MIN	.086	.000*	.025	.030	.195	.018	.235	.205	.250	.170		.370	.055			.035	.025*	.035†	00	0°
sion	NOM	-	-	-	-	-	-	.240	-	-	-	.090 BSC	-	.060	.108 REF	.020 BSC	-	-	-	-	-
(inches)	MAX	.094	.005	.035	.045	.215	.035	.245	.217*	.265	.200*		.410	.070			.050	.040	.060	10º	15°

JEDEC Registration TO-252, Variation AA, Issue E, June 2004. * This dimension is not specified in the JEDEC drawing.

This dimension is not specified in the JEDEC drawing. This dimension differs from the JEDEC drawing.

Drawings not to scale.

3-Lead TO-92 Package Outline (L/LL/N3)



Bottom View

Note: For the most current package drawings, see the Microchip Packaging Specification at www.microchip.com/packaging.

Symbol		А	b	с	D	E	E1	е	e1	L
	MIN	.170	.014†	.014†	.175	.125	.080	.095	.045	.500
Dimensions (inches)	NOM	-	-	-	-	-	-	-	-	-
(incres)	MAX	.210	.022†	.022†	.205	.165	.105	.105	.055	.610*

JEDEC Registration TO-92. * This dimension is not specified in the JEDEC drawing. † This dimension differs from the JEDEC drawing. Drawings not to scale.

NOTES:

APPENDIX A: REVISION HISTORY

Revision A (December 2018)

- Converted Supertex Doc# DSFP-CL520/CL525 to Microchip DS20005805A
- Changed the maximum junction temperature in the Absolute Maximum Ratings from 150°C to 135°C
- · Changed the package marking format
- Made minor text changes throughout the document.

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, contact your local Microchip representative or sales office.

PART NO.	<u>xx</u>	- <u>x</u> - <u>x</u>	Examples:	
Device	Package Options	Environmental Media Type	a) CL520K4-G:	Fixed Constant-Current Linear LED Driver, 3-lead TO-252 (DPAK) Package, 2000/Reel
Devices:	CL520 = CL525 =		b) CL520N3-G:	Fixed Constant-Current Linear LED Driver, 3-lead TO-92 Package,1000/Bag
Packages:	K4 =	3-lead TO-252 (DPAK)	c) CL525K4-G:	Fixed Constant-Current Linear
	N3 =	3-lead TO-92	0, 0101011 01	LED Driver, 3-lead TO-252 (DPAK) Package, 2000/Reel
Environmental:	G =	Lead (Pb)-free/RoHS-compliant Package		
Modia Typos:	(blank) =	2000/Pool for a K4 Pookaga	d) CL525N3-G:	Fixed Constant-Current Linear LED Driver, 3-lead TO-92
Media Types:	(4.4)	g.		Package,1000/Bag
	(blank) =	1000/Bag for an N3 Package		

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